- Wide Operating Voltage Range of 2 V to 6 V
- Outputs Can Drive Up To 15 LSTTL Loads
- Low Power Consumption, 80- $\mu \mathrm{A}$ Max ICC
- Typical $\mathrm{t}_{\mathrm{pd}}=9 \mathrm{~ns}$
- $\pm 6$-mA Output Drive at 5 V

SN54HC153... J OR W PACKAGE
SN74HC153 . . . D, N, NS, OR PW PACKAGE
(TOP VIEW)


- Low Input Current of $1 \mu \mathrm{~A}$ Max
- Permit Multiplexing from $\mathbf{n}$ Lines to One Line
- Perform Parallel-to-Serial Conversion
- Strobe (Enable) Line Provided for Cascading ( N Lines to n Lines)

SN54HC153... FK PACKAGE
(TOP VIEW)


NC - No internal connection

## description/ordering information

Each of these data selectors/multiplexers contains inverters and drivers to supply full binary decoding data selection to the AND-OR gates. Separate strobe $(\overline{\mathrm{G}})$ inputs are provided for each of the two 4 -line sections.

ORDERING INFORMATION

| $\mathrm{T}_{\mathrm{A}}$ | PACKAGE $\dagger$ |  | ORDERABLE PART NUMBER | TOP-SIDE MARKING |
| :---: | :---: | :---: | :---: | :---: |
| $-40^{\circ} \mathrm{C}$ to $85^{\circ} \mathrm{C}$ | PDIP - N | Tube of 25 | SN74HC153N | SN74HC153N |
|  | SOIC - D | Tube of 40 | SN74HC153D | HC153 |
|  |  | Reel of 2500 | SN74HC153DR |  |
|  |  | Reel of 250 | SN74HC153DT |  |
|  | SOP - NS | Reel of 2000 | SN74HC153NSR | HC153 |
|  | TSSOP - PW | Tube of 90 | SN74HC153PW | HC153 |
|  |  | Reel of 2000 | SN74HC153PWR |  |
|  |  | Reel of 250 | SN74HC153PWT |  |
| $-55^{\circ} \mathrm{C}$ to $125^{\circ} \mathrm{C}$ | CDIP - J | Tube of 25 | SNJ54HC153J | SNJ54HC153J |
|  | CFP - W | Tube of 150 | SNJ54HC153W | SNJ54HC153W |
|  | LCCC - FK | Tube of 55 | SNJ54HC153FK | SNJ54HC153FK |

† Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.

Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

| INPUTS |  |  |  |  |  |  | $\begin{gathered} \text { OUTPUT } \\ \mathbf{Y} \end{gathered}$ |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| SELECT $\dagger$ |  | DATA |  |  |  | $\overline{\mathrm{G}}$ |  |
| B | A | C0 | C1 | C2 | C3 |  |  |
| X | X | X | X | X | X | H | L |
| L | L | L | X | X | X | L | L |
| L | L | H | X | X | X | L | H |
| L | H | X | L | X | X | L | L |
| L | H | X | H | X | X | L | H |
| H | L | X | X | L | X | L | L |
| H | L | X | X | H | X | L | H |
| H | H | X | X | X | L | L | L |
| H | H | X | X | X | H | L | H |

$\dagger$ Select inputs A and B are common to both sections.
logic diagram (positive logic)


Pin numbers shown are for the $\mathrm{D}, \mathrm{J}, \mathrm{N}, \mathrm{NS}, \mathrm{PW}$, and W packages.

## DUAL 4-LINE TO 1-LINE DATA SELECTORS/MULTIPLEXERS

SCLS112D - DECEMBER 1982 - REVISED OCTOBER 2003

## absolute maximum ratings over operating free-air temperature range (unless otherwise noted) $\dagger$

$$
\begin{aligned}
& \text { Supply voltage range, } \mathrm{V}_{\mathrm{CC}} \text {. . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . } 0.5 \mathrm{~V} \text { to } 7 \mathrm{~V} \\
& \text { Input clamp current, } \mathrm{I}_{\mathrm{IK}}\left(\mathrm{~V}_{\mathrm{I}}<0 \text { or } \mathrm{V}_{\mathrm{I}}>\mathrm{V}_{\mathrm{CC}}\right) \text { (see Note 1) . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . } \pm 20 \mathrm{~mA}
\end{aligned}
$$

$$
\begin{aligned}
& \text { Continuous output current, } \mathrm{I}_{\mathrm{O}}\left(\mathrm{~V}_{\mathrm{O}}=0 \text { to } \mathrm{V}_{\mathrm{CC}}\right) \text {. . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . } \pm 35 \mathrm{~mA} \\
& \text { Continuous current through VCC or GND . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . } \pm 70 \mathrm{~mA} \\
& \text { Package thermal impedance, } \theta_{\text {JA }} \text { (see Note 2): D package . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . 73} \mathrm{C} / \mathrm{W} \\
& \text { N package . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . } 67^{\circ} \mathrm{C} / \mathrm{W} \\
& \text { NS package . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . } 64^{\circ} \mathrm{C} / \mathrm{W} \\
& \text { PW package ............................................. } 108^{\circ} \mathrm{C} / \mathrm{W} \\
& \text { Storage temperature range, } T_{\text {stg }} \text {. . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . }-65^{\circ} \mathrm{C} \text { to } 150^{\circ} \mathrm{C} \\
& \dagger \text { Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and } \\
& \text { functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not } \\
& \text { implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability. } \\
& \text { NOTES: 1. The input and output voltage ratings may be exceeded if the input and output current ratings are observed. } \\
& \text { 2. The package thermal impedance is calculated in accordance with JESD 51-7. }
\end{aligned}
$$

recommended operating conditions (see Note 3)

|  |  |  | SN54HC153 |  |  | SN74HC153 |  |  | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | MIN | NOM | MAX | MIN | NOM | MAX |  |
| $\mathrm{V}_{\mathrm{CC}}$ | Supply voltage |  | 2 | 5 | 6 | 2 | 5 | 6 | V |
|  |  | $\mathrm{V}_{\mathrm{CC}}=2 \mathrm{~V}$ | 1.5 |  |  | 1.5 |  |  |  |
| $\mathrm{V}_{\mathrm{IH}}$ | High-level input voltage | $\mathrm{V}_{\mathrm{CC}}=4.5 \mathrm{~V}$ | 3.15 |  |  | 3.15 |  |  | V |
|  |  | $\mathrm{V}_{\mathrm{CC}}=6 \mathrm{~V}$ | 4.2 |  |  | 4.2 |  |  |  |
|  |  | $\mathrm{V}_{\mathrm{CC}}=2 \mathrm{~V}$ |  |  | 0.5 |  |  | 0.5 |  |
| $\mathrm{V}_{\text {IL }}$ | Low-level input voltage | $\mathrm{V}_{\mathrm{CC}}=4.5 \mathrm{~V}$ |  |  | 1.35 |  |  | 1.35 | V |
|  |  | $\mathrm{V}_{\mathrm{CC}}=6 \mathrm{~V}$ |  |  | 1.8 |  |  | 1.8 |  |
| $\mathrm{V}_{1}$ | Input voltage |  | 0 |  | $\mathrm{V}_{\mathrm{CC}}$ | 0 |  | $\mathrm{V}_{\mathrm{CC}}$ | V |
| $\mathrm{V}_{\mathrm{O}}$ | Output voltage |  | 0 |  | $\mathrm{V}_{\mathrm{CC}}$ | 0 |  | $\mathrm{V}_{\mathrm{CC}}$ | V |
|  |  | $\mathrm{V}_{\mathrm{CC}}=2 \mathrm{~V}$ |  |  | 1000 |  |  | 1000 |  |
| $\Delta t / \Delta v$ | Input transition rise/fall time | $\mathrm{V}_{\mathrm{CC}}=4.5 \mathrm{~V}$ |  |  | 500 |  |  | 500 | ns |
|  |  | $\mathrm{V}_{\mathrm{CC}}=6 \mathrm{~V}$ |  |  | 400 |  |  | 400 |  |
| $\mathrm{T}_{\mathrm{A}}$ | Operating free-air temperatu |  | -55 |  | 125 | -40 |  | 85 | ${ }^{\circ} \mathrm{C}$ |

NOTE 3: All unused inputs of the device must be held at $\mathrm{V}_{\mathrm{CC}}$ or GND to ensure proper device operation. Refer to the TI application report, Implications of Slow or Floating CMOS Inputs, literature number SCBA004.
electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

| PARAMETER | TEST CONDITIONS |  | $\mathrm{V}_{\mathrm{CC}}$ | $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ |  |  | SN54HC153 |  | SN74HC153 |  | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | MIN | TYP | MAX | MIN | MAX | MIN | MAX |  |
| $\mathrm{V}_{\mathrm{OH}}$ | $\mathrm{V}_{\mathrm{I}}=\mathrm{V}_{\mathrm{IH}}$ or $\mathrm{V}_{\mathrm{IL}}$ | $\mathrm{l} \mathrm{OH}=-20 \mu \mathrm{~A}$ |  | 2 V | 1.9 | 1.998 |  | 1.9 |  | 1.9 |  | V |
|  |  |  | 4.5 V | 4.4 | 4.499 |  | 4.4 |  | 4.4 |  |  |  |
|  |  |  | 6 V | 5.9 | 5.999 |  | 5.9 |  | 5.9 |  |  |  |
|  |  | $\mathrm{OH}=-6 \mathrm{~mA}$ | 4.5 V | 3.98 | 4.3 |  | 3.7 |  | 3.84 |  |  |  |
|  |  | $\mathrm{OH}=-7.8 \mathrm{~mA}$ | 6 V | 5.48 | 5.8 |  | 5.2 |  | 5.34 |  |  |  |
| VOL | $\mathrm{V}_{\mathrm{I}}=\mathrm{V}_{\mathrm{IH}}$ or $\mathrm{V}_{\mathrm{IL}}$ | ${ }^{\mathrm{I}} \mathrm{OL}=20 \mu \mathrm{~A}$ | 2 V |  | 0.002 | 0.1 |  | 0.1 |  | 0.1 | V |  |
|  |  |  | 4.5 V |  | 0.001 | 0.1 |  | 0.1 |  | 0.1 |  |  |
|  |  |  | 6 V |  | 0.001 | 0.1 |  | 0.1 |  | 0.1 |  |  |
|  |  | $\mathrm{I} \mathrm{OL}=6 \mathrm{~mA}$ | 4.5 V |  | 0.17 | 0.26 |  | 0.4 |  | 0.33 |  |  |
|  |  | $\mathrm{IOL}=7.8 \mathrm{~mA}$ | 6 V |  | 0.15 | 0.26 |  | 0.4 |  | 0.33 |  |  |
| 1 | $\mathrm{V}_{1}=\mathrm{V}_{\mathrm{CC}}$ or 0 |  | 6 V |  | $\pm 0.1$ | $\pm 100$ |  | $\pm 1000$ |  | $\pm 1000$ | nA |  |
| ICC | $\mathrm{V}_{\mathrm{I}}=\mathrm{V}_{\mathrm{CC}}$ or $0, \quad \mathrm{I} \mathrm{O}=0$ |  | 6 V |  |  | 8 |  | 160 |  | 80 | $\mu \mathrm{A}$ |  |
| $\mathrm{C}_{\mathrm{i}}$ |  |  | 2 V to 6 V |  | 3 | 10 |  | 10 |  | 10 | pF |  |

switching characteristics over recommended operating free-air temperature range, $\mathrm{C}_{\mathrm{L}}=50 \mathrm{pF}$ (unless otherwise noted) (see Figure 1)

| PARAMETER | FROM (INPUT) | TO (OUTPUT) | VCC | $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ |  |  | SN54HC153 |  | SN74HC153 |  | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  | MIN | TYP | MAX | MIN | MAX | MIN | MAX |  |
| ${ }^{\text {tpd }}$ | A or B | Y | 2 V |  | 90 | 150 |  | 225 |  | 190 | ns |
|  |  |  | 4.5 V |  | 21 | 30 |  | 45 |  | 38 |  |
|  |  |  | 6 V |  | 17 | 26 |  | 38 |  | 32 |  |
|  | Data <br> (Any C) | Y | 2 V |  | 73 | 126 |  | 189 |  | 158 |  |
|  |  |  | 4.5 V |  | 17 | 28 |  | 42 |  | 35 |  |
|  |  |  | 6 V |  | 14 | 23 |  | 35 |  | 29 |  |
|  | $\overline{\mathrm{G}}$ | Y | 2 V |  | 38 | 95 |  | 150 |  | 125 |  |
|  |  |  | 4.5 V |  | 11 | 19 |  | 28 |  | 24 |  |
|  |  |  | 6 V |  | 9 | 16 |  | 24 |  | 20 |  |
| $t_{t}$ |  | Y | 2 V |  | 20 | 60 |  | 90 |  | 75 | ns |
|  |  |  | 4.5 V |  | 8 | 12 |  | 18 |  | 15 |  |
|  |  |  | 6 V |  | 6 | 10 |  | 15 |  | 13 |  |

## DUAL 4-LINE TO 1-LINE DATA SELECTORS/MULTIPLEXERS

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switching characteristics over recommended operating free-air temperature range, $\mathrm{C}_{\mathrm{L}}=150 \mathrm{pF}$ (unless otherwise noted) (see Figure 1)

| PARAMETER | FROM (INPUT) | TO (OUTPUT) | $V_{C C}$ | $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ |  |  | SN54HC153 |  | SN74HC153 |  | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  | MIN | TYP | MAX | MIN | MAX | MIN | MAX |  |
| ${ }^{\text {tpd }}$ | A or B | Y | 2 V |  | 105 | 235 |  | 355 |  | 295 | ns |
|  |  |  | 4.5 V |  | 27 | 47 |  | 71 |  | 59 |  |
|  |  |  | 6 V |  | 21 | 41 |  | 60 |  | 51 |  |
|  | $\begin{gathered} \text { Data } \\ \text { (Any C) } \end{gathered}$ | Y | 2 V |  | 93 | 220 |  | 335 |  | 274 |  |
|  |  |  | 4.5 V |  | 23 | 44 |  | 67 |  | 55 |  |
|  |  |  | 6 V |  | 19 | 38 |  | 57 |  | 48 |  |
|  | $\overline{\mathrm{G}}$ | Y | 2 V |  | 60 | 185 |  | 280 |  | 230 |  |
|  |  |  | 4.5 V |  | 17 | 37 |  | 56 |  | 46 |  |
|  |  |  | 6 V |  | 14 | 32 |  | 48 |  | 40 |  |
| $t_{t}$ |  | Y | 2 V |  | 45 | 210 |  | 315 |  | 265 | ns |
|  |  |  | 4.5 V |  | 17 | 42 |  | 63 |  | 53 |  |
|  |  |  | 6 V |  | 13 | 36 |  | 53 |  | 45 |  |

operating characteristics, $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$

| PARAMETER | TEST CONDITIONS | TYP | UNIT |
| :---: | :---: | :---: | :---: |
| $\mathrm{C}_{\text {pd }}$ | Power dissipation capacitance per multiplexer | No load | 40 |

## PARAMETER MEASUREMENT INFORMATION



Figure 1. Load Circuit and Voltage Waveforms

## PACKAGING INFORMATION

| Orderable Device | Status ${ }^{(1)}$ | Package Type | Package Drawing | Pins | Package Qty | $\text { Eco Plan }{ }^{(2)}$ | Lead/Ball Finish | MSL Peak Temp ${ }^{(3)}$ |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 84093012A | ACTIVE | LCCC | FK | 20 | 1 | TBD | POST-PLATE | N/ A for Pkg Type |
| 8409301EA | ACTIVE | CDIP | J | 16 | 1 | TBD | A42 SNPB | N / A for Pkg Type |
| 8409301FA | ACTIVE | CFP | W | 16 | 1 | TBD | A42 | N / A for Pkg Type |
| SN54HC153J | ACTIVE | CDIP | J | 16 | 1 | TBD | A42 SNPB | N / A for Pkg Type |
| SN74HC153D | ACTIVE | SOIC | D | 16 | 40 | $\begin{gathered} \text { Green (RoHS \& } \\ \text { no } \mathrm{Sb} / \mathrm{Br}) \end{gathered}$ | CU NIPDAU | Level-1-260C-UNLIM |
| SN74HC153DE4 | ACTIVE | SOIC | D | 16 | 40 | $\begin{gathered} \hline \text { Green (RoHS \& } \\ \text { no } \mathrm{Sb} / \mathrm{Br} \text { ) } \\ \hline \end{gathered}$ | CU NIPDAU | Level-1-260C-UNLIM |
| SN74HC153DR | ACTIVE | SOIC | D | 16 | 2500 | Green (RoHS \& no $\mathrm{Sb} / \mathrm{Br}$ ) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74HC153DRE4 | ACTIVE | SOIC | D | 16 | 2500 | Green (RoHS \& no $\mathrm{Sb} / \mathrm{Br})$ | CU NIPDAU | Level-1-260C-UNLIM |
| SN74HC153DRG4 | ACTIVE | SOIC | D | 16 | 2500 | $\begin{gathered} \text { Green (RoHS \& } \\ \text { no } \mathrm{Sb} / \mathrm{Br}) \end{gathered}$ | CU NIPDAU | Level-1-260C-UNLIM |
| SN74HC153DT | ACTIVE | SOIC | D | 16 | 250 | $\begin{gathered} \text { Green (RoHS \& } \\ \text { no } \mathrm{Sb} / \mathrm{Br}) \end{gathered}$ | CU NIPDAU | Level-1-260C-UNLIM |
| SN74HC153DTE4 | ACTIVE | SOIC | D | 16 | 250 | $\begin{gathered} \hline \text { Green (RoHS \& } \\ \text { no } \mathrm{Sb} / \mathrm{Br}) \end{gathered}$ | CU NIPDAU | Level-1-260C-UNLIM |
| SN74HC153N | ACTIVE | PDIP | N | 16 | 25 | Pb-Free (RoHS) | CU NIPDAU | N/ A for Pkg Type |
| SN74HC153NE4 | ACTIVE | PDIP | N | 16 | 25 | Pb-Free (RoHS) | CU NIPDAU | N/ A for Pkg Type |
| SN74HC153NSR | ACTIVE | SO | NS | 16 | 2000 | $\begin{gathered} \text { Green (RoHS \& } \\ \text { no } \mathrm{Sb} / \mathrm{Br} \text { ) } \\ \hline \end{gathered}$ | CU NIPDAU | Level-1-260C-UNLIM |
| SN74HC153NSRE4 | ACTIVE | SO | NS | 16 | 2000 | $\begin{gathered} \text { Green (RoHS \& } \\ \text { no } \mathrm{Sb} / \mathrm{Br} \text { ) } \end{gathered}$ | CU NIPDAU | Level-1-260C-UNLIM |
| SN74HC153PW | ACTIVE | TSSOP | PW | 16 | 90 | Green (RoHS \& no $\mathrm{Sb} / \mathrm{Br}$ ) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74HC153PWE4 | ACTIVE | TSSOP | PW | 16 | 90 | $\begin{gathered} \text { Green (RoHS \& } \\ \text { no } \mathrm{Sb} / \mathrm{Br} \text { ) } \end{gathered}$ | CU NIPDAU | Level-1-260C-UNLIM |
| SN74HC153PWLE | OBSOLETE | TSSOP | PW | 16 |  | TBD | Call TI | Call TI |
| SN74HC153PWR | ACTIVE | TSSOP | PW | 16 | 2000 | $\begin{gathered} \text { Green (RoHS \& } \\ \text { no } \mathrm{Sb} / \mathrm{Br} \text { ) } \end{gathered}$ | CU NIPDAU | Level-1-260C-UNLIM |
| SN74HC153PWRE4 | ACTIVE | TSSOP | PW | 16 | 2000 | $\begin{gathered} \text { Green (RoHS \& } \\ \text { no } \mathrm{Sb} / \mathrm{Br} \text { ) } \end{gathered}$ | CU NIPDAU | Level-1-260C-UNLIM |
| SN74HC153PWT | ACTIVE | TSSOP | PW | 16 | 250 | $\begin{gathered} \text { Green (RoHS \& } \\ \text { no } \mathrm{Sb} / \mathrm{Br} \text { ) } \end{gathered}$ | CU NIPDAU | Level-1-260C-UNLIM |
| SN74HC153PWTE4 | ACTIVE | TSSOP | PW | 16 | 250 | $\begin{gathered} \text { Green (RoHS \& } \\ \text { no } \mathrm{Sb} / \mathrm{Br} \text { ) } \\ \hline \end{gathered}$ | CU NIPDAU | Level-1-260C-UNLIM |
| SNJ54HC153FK | ACTIVE | LCCC | FK | 20 | 1 | TBD | POST-PLATE | N/ A for Pkg Type |
| SNJ54HC153J | ACTIVE | CDIP | J | 16 | 1 | TBD | A42 SNPB | N/A for Pkg Type |
| SNJ54HC153W | ACTIVE | CFP | W | 16 | 1 | TBD | A42 | N/ A for Pkg Type |

[^0]OBSOLETE: TI has discontinued the production of the device.
${ }^{(2)}$ Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS \& no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.
TBD: The Pb-Free/Green conversion plan has not been defined.
Pb -Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed $0.1 \%$ by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb -Free products are suitable for use in specified lead-free processes.
Pb -Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.
Green (RoHS \& no $\mathbf{S b} / \mathbf{B r}$ ): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants ( Br or Sb do not exceed $0.1 \%$ by weight in homogeneous material)
${ }^{(3)}$ MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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| DIM PINS ** | 14 | 16 | 18 | 20 |
| :---: | :---: | :---: | :---: | :---: |
| A | 0.300 <br> $(7,62)$ <br> BSC | 0.300 <br> $(7,62)$ <br> BSC | 0.300 <br> $(7,62)$ <br> BSC | 0.300 <br> $(7,62)$ <br> BSC |
| B MAX | 0.785 <br> $(19,94)$ | .840 <br> $(21,34)$ | 0.960 <br> $(24,38)$ | 1.060 <br> $(26,92)$ |
| B MIN | - | - | - | - |
| C MAX | 0.300 <br> $(7,62)$ | 0.300 <br> $(7,62)$ | 0.310 <br> $(7,87)$ | 0.300 <br> $(7,62)$ |
| C MIN | 0.245 <br> $(6,22)$ | 0.245 <br> $(6,22)$ | 0.220 <br> $(5,59)$ | 0.245 <br> $(6,22)$ |



NOTES: A. All linear dimensions are in inches (millimeters).
B. This drawing is subject to change without notice.
C. This package is hermetically sealed with a ceramic lid using glass frit.
D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
E. Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

W (R-GDFP-F16)


NOTES: A. All linear dimensions are in inches (millimeters).
B. This drawing is subject to change without notice.
C. This package can be hermetically sealed with a ceramic lid using glass frit.
D. Index point is provided on cap for terminal identification only.
E. Falls within MIL STD 1835 GDFP1-F16 and JEDEC MO-092AC

FK (S-CQCC-N**)


NOTES: A. All linear dimensions are in inches (millimeters).
B. This drawing is subject to change without notice.
C. This package can be hermetically sealed with a metal lid.
D. The terminals are gold plated.
E. Falls within JEDEC MS-004

N (R-PDIP-T**)
PLASTIC DUAL-IN-LINE PACKAGE
16 PINS SHOWN


NOTES: A. All linear dimensions are in inches (millimeters).
B. This drawing is subject to change without notice.
C) Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).

D The 20 pin end lead shoulder width is a vendor option, either half or full width.

D (R-PDSO-G16)

## PLASTIC SMALL-OUTLINE PACKAGE



NOTES: A. All linear dimensions are in inches (millimeters).
B. This drawing is subject to change without notice.
C. Body dimensions do not include mold flash or protrusion not to exceed $0.006(0,15)$.
D. Falls within JEDEC MS-012 variation AC.

NS (R-PDSO-G**)
14-PINS SHOWN


| DIM PINS ** | 14 | 16 | 20 | 24 |
| :---: | :---: | :---: | :---: | :---: |
| A MAX | 10,50 | 10,50 | 12,90 | 15,30 |
| A MIN | 9,90 | 9,90 | 12,30 | 14,70 |

NOTES: A. All linear dimensions are in millimeters.
B. This drawing is subject to change without notice.
C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.


| PIMS $^{* *}$ | $\mathbf{8}$ | $\mathbf{1 4}$ | $\mathbf{1 6}$ | $\mathbf{2 0}$ | $\mathbf{2 4}$ | $\mathbf{2 8}$ |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| A MAX | 3,10 | 5,10 | 5,10 | 6,60 | 7,90 | 9,80 |
| A MIN | 2,90 | 4,90 | 4,90 | 6,40 | 7,70 | 9,60 |

NOTES: A. All linear dimensions are in millimeters.
B. This drawing is subject to change without notice.
C. Body dimensions do not include mold flash or protrusion not to exceed 0,15 .
D. Falls within JEDEC MO-153

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